PRELIMINARY

ICS8343I-01

Low Skew, 1-to-16 LVCMOS / LVTTL Fanout Buffer

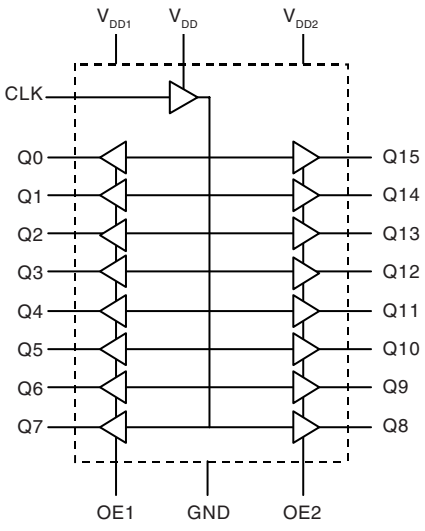
General Description

The ICS8343I-01 is a low skew, 1-to-16 LVCMOS/LVTTL Fanout Buffer and a member of the HiPerClockS™ family of High Performance Clock Solutions from IDT. The ICS8343I-01 single ended clock input accepts LVCMOS or LVTTL input levels. The ICS8343I-01 operates at 3.3V, 2.5V and mixed 3.3V input and 2.5V supply modes over the industrial temperature range. Guaranteed output and part-to-part skew characteristics make the ICS8343I-01 ideal for those clock distribution applications demanding well defined performance and repeatability.

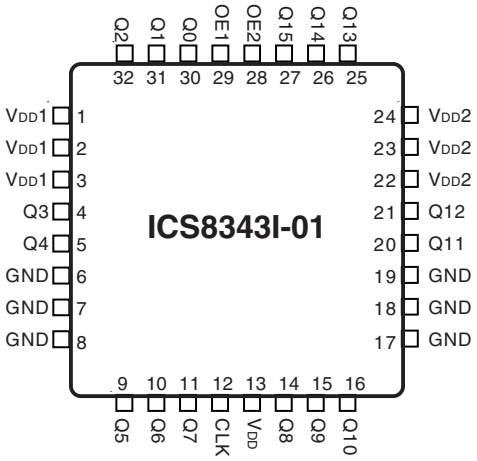
Features

- 16 LVCMOS/LVTTL outputs
- 1 LVCMOS/LVTTL clock input
- CLK can accept the following input levels: LVCMOS, LVTTL
- Maximum output frequency: 200MHz
- Dual output enable inputs facilitates 1-to-16 or 1-to-8 input to output modes
- All inputs are 5V tolerant
- Output skew: 250ps (typical)
- Part-to-part skew: 700ps (typical)
- Full 3.3V and 2.5V or mixed 3.3V core/2.5V operating supply
- -40°C to 85°C ambient operating temperature

Block Diagram



Pin Assignment



32-Lead LQFP
7mm x 7mm x 1.4mm body package
Y Package
(Top View)

The Preliminary Information presented herein represents a product in pre-production. The noted characteristics are based on initial product characterization and/or qualification. Integrated Device Technology, Incorporated (IDT) reserves the right to change any circuitry or specifications without notice.

TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1, 2, 3	V_{DD1}	Power		Q0 thru Q7 output supply pins.
4, 5	Q3, Q4	Output		LVCMOS/LVTTL clock outputs. 7Ω typical output impedance.
6, 7, 8, 17, 18, 19	GND	Power		Power supply ground.
9, 10, 11	Q5, Q6, Q7	Output		LVCMOS/LVTTL clock outputs. 7Ω typical output impedance.
12	CLK	Input	Pulldown	LVCMOS/LVTTL clock input / 5V tolerant.
13	V_{DD}	Power		Core supply pin.
14, 15, 16	Q8, Q9, Q10	Output		LVCMOS/LVTTL clock outputs. 7Ω typical output impedance.
20, 21	Q11, Q12	Output		LVCMOS/LVTTL clock outputs. 7Ω typical output impedance.
22, 23, 24	V_{DD2}	Power		Q8 thru Q15 output supply pins.
25, 26, 27	Q13, Q14, Q15	Output		LVCMOS/LVTTL clock outputs. 7Ω typical output impedance.
28	OE2	Input	Pullup	Output enable. When low forces outputs Q8 thru Q15 to HiZ state. 5V tolerant. LVCMOS/LVTTL interface levels.
29	OE1	Input	Pullup	Output enable. When low forces outputs Q0 thru Q7 to HiZ state. 5V tolerant. LVCMOS/LVTTL interface levels.
30, 31, 32	Q0, Q1, Q2	Output		LVCMOS/LVTTL clock outputs. 7Ω typical output impedance.

NOTE: *Pullup* and *Pulldown* refer to internal input resistors. See Table 2, Pin characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
C_{PD}	Power Dissipation Capacitance (per output)	V_{DD}, V_{DD1}, V_{DD2} = 3.465V		11		pF
		V_{DD1}, V_{DD2} = 2.63V		9		pF
R_{PULLUP}	Input Pullup Resistor			51		KΩ
$R_{PULLDOWN}$	Input Pulldown Resistor			51		KΩ
R_{OUT}	Output Impedance	V_{DD}, V_{DD1}, V_{DD2} = 3.3V	5	7	12	Ω

TABLE 3. FUNCTION TABLE

Inputs		Outputs	
OE1	OE2	Q0:Q7	Q8:Q15
0	0	HiZ	HiZ
1	0	Active	HiZ
0	1	HiZ	Active
1	1	Active	Active

NOTE: OE1 and OE2 are 5V tolerant.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to V_{DD} + 0.5 V
Outputs, V_O	-0.5V to V_{DDx} + 0.5V
Package Thermal Impedance, θ_{JA}	73.6°C/W (0 mps)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 4A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 3.3V \pm 5\%$, T_A = -40° TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V_{DDx}	Output Supply Voltage; NOTE 1		3.135	3.3	3.465	V
I_{DD}	Power Supply Current				35	mA
I_{DDx}	Output Supply Current; NOTE 2				14	mA

NOTE 1: V_{DDx} denotes V_{DD1} and V_{DD2}.
NOTE 2: I_{DDx} denotes the sum of I_{DD1} and I_{DD2}.

TABLE 4B. LVCMOS / LVTTL DC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 3.3V \pm 5\%$, T_A = -40° TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	OE1, OE2		2		V_{DD} + 0.3	V
		CLK		2		V_{DD} + 0.3	V
V_{IL}	Input Low Voltage	OE1, OE2		-0.3		0.8	V
		CLK		-0.3		1.3	V
I_{IH}	Input High Current	OE1, OE2	$V_{DD} = V_{IN} = 3.465V$			5	µA
		CLK	$V_{DD} = V_{IN} = 3.465V$			150	µA
I_{IL}	Input Low Current	OE1, OE2	$V_{DD} = 3.465V$, $V_{IN} = 0V$	-150			µA
		CLK	$V_{DD} = 3.465V$, $V_{IN} = 0V$	-5			µA
V_{OH}	Output High Voltage; NOTE 1			2.6			V
V_{OL}	Output Low Voltage; NOTE 1					0.5	V
I_{OZL}	Output Tristate Current Low					5	µA
I_{OZH}	Output Tristate Current High					5	µA

NOTE 1: Outputs terminated with 50Ω to $V_{DDx}/2$. See Parameter Measurement Information, 3.3V Output Load Test Circuit.

TABLE 4C. POWER SUPPLY DC CHARACTERISTICS, V_{DD} = 3.3V±5%, V_{DD1} = V_{DD2} = 2.5V±5%, T_A = -40° TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		3.135	3.3	3.465	V
V_{DDx}	Output Supply Voltage; NOTE 1		2.375	2.5	2.625	V
I_{DD}	Power Supply Current				35	mA
I_{DDx}	Output Supply Current; NOTE 2				14	mA

NOTE 1: V_{DDx} denotes V_{DD1} and V_{DD2}.
NOTE 2: I_{DDx} denotes the sum of I_{DD1} and I_{DD2}.

TABLE 4D. LVCMOS / LVTTL DC CHARACTERISTICS, V_{DD} = 3.3V±5%, V_{DD1} = V_{DD2} = 2.5V±5%, T_A = -40° TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	OE1, OE2		2		V_{DD} + 0.3	V
		CLK		2		V_{DD} + 0.3	V
V_{IL}	Input Low Voltage	OE1, OE2		-0.3		0.8	V
		CLK		-0.3		1.3	V
I_{IH}	Input High Current	OE1, OE2	V_{DD} = V_{IN} = 3.465V			5	µA
		CLK	V_{DD} = V_{IN} = 3.465V			150	µA
I_{IL}	Input Low Current	OE1, OE2	V_{DD} = 3.465V, V_{IN} = 0V	-150			µA
		CLK	V_{DD} = 3.465V, V_{IN} = 0V	-5			µA
V_{OH}	Output High Voltage; NOTE 1			1.8			V
V_{OL}	Output Low Voltage; NOTE 1					0.5	V
I_{OZL}	Output Tristate Current Low					5	µA
I_{OZH}	Output Tristate Current High					5	µA

NOTE 1: Outputs terminated with 50Ω to V_{DDx}/2. See Parameter Measurement Information, 3.3V/2.5 Output Load Test Circuit.

TABLE 4E. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 2.5V±5\%$, $T_A = -40°$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Core Supply Voltage		2.375	2.5	2.625	V
V_{DDx}	Output Supply Voltage; NOTE 1		2.375	2.5	2.625	V
I_{DD}	Power Supply Current				34	mA
I_{DDx}	Output Supply Current; NOTE 2				13	mA

NOTE 1: V_{DDx} denotes V_{DD1} and V_{DD2}.
NOTE 2: I_{DDx} denotes the sum of I_{DD1} and I_{DD2}.

TABLE 4F. LVCMOS / LVTTL DC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 2.5V±5\%$, $T_A = -40°$ TO 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	OE1, OE2		2		V_{DD} + 0.3	V
		CLK		2		V_{DD} + 0.3	V
V_{IL}	Input Low Voltage	OE1, OE2		-0.3		0.8	V
		CLK		-0.3		1.3	V
I_{IH}	Input High Current	OE1, OE2	$V_{DD} = V_{IN} = 2.625V$			5	µA
		CLK	$V_{DD} = V_{IN} = 2.625V$			150	µA
I_{IL}	Input Low Current	OE1, OE2	$V_{DD} = 2.625V$, $V_{IN} = 0V$	-150			µA
		CLK	$V_{DD} = 2.625V$, $V_{IN} = 0V$	-5			µA
V_{OH}	Output High Voltage; NOTE 1			1.8			V
V_{OL}	Output Low Voltage; NOTE 1					0.5	V
I_{OZL}	Output Tristate Current Low					5	µA
I_{OZH}	Output Tristate Current High					5	µA

NOTE 1: Outputs terminated with 50Ω to $V_{DDx}/2$. See Parameter Measurement Information, 2.5V Output Load Test Circuit.

TABLE 5A. AC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 3.3V±5\%$, $T_A = -40°$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Onput Frequency				200	MHz
t_{pLH}	Propagation Delay; NOTE 1	$f \leq$ 200MHz		3		ns
*t*sk(o)	Output Skew; NOTE 2, 4	Measured on rising edge @$V_{DDx}/2$		250		ps
*t*sk(pp)	Part-to-Part Skew; NOTE 3, 4	Measured on rising edge @$V_{DDx}/2$		700		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	0.4		1.5	ns
odc	Output Duty Cycle	$f \leq$ 133MHz		50		%
t_{PW}	Output Pulse Width	$f >$ 133MHz		$t_{PERIOD}/2$		ns

All parameters measured at f_{MAX} unless noted otherwise.
NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDx}/2$ of the output.
NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDx}/2$.
NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDx}/2$.
NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

TABLE 5B. AC CHARACTERISTICS, $V_{DD} = 3.3V±5\%$, $V_{DD1} = V_{DD2} = 2.5V±5\%$, $T_A = -40°$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Onput Frequency				200	MHz
t_{pLH}	Propagation Delay; NOTE 1	$f \leq$ 200MHz		3.25		ns
*t*sk(o)	Output Skew; NOTE 2, 4	Measured on rising edge @$V_{DDx}/2$		250		ps
*t*sk(pp)	Part-to-Part Skew; NOTE 3, 4	Measured on rising edge @$V_{DDx}/2$		700		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	0.4		1.0	ns
odc	Output Duty Cycle	$f \leq$ 133MHz		50		%

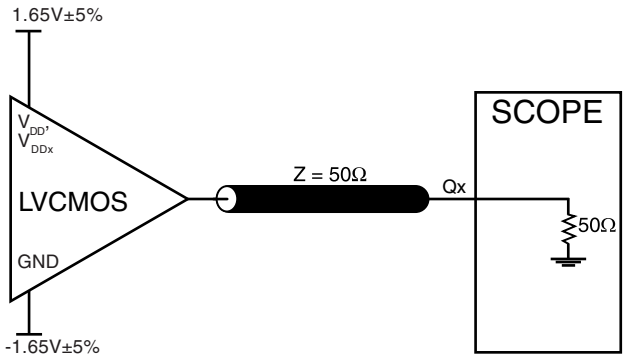
All parameters measured at f_{MAX} unless noted otherwise.
NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDx}/2$ of the output.
NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDx}/2$.
NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDx}/2$.
NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

TABLE 5C. AC CHARACTERISTICS, $V_{DD} = V_{DD1} = V_{DD2} = 2.5V±5\%$, $T_A = -40°$ TO 85°C

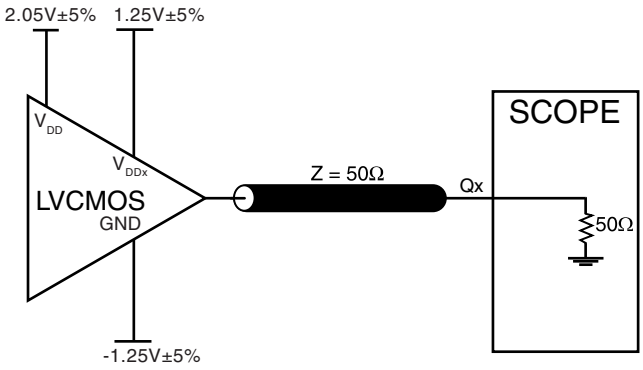
Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{MAX}	Onput Frequency				133	MHz
t_{pLH}	Propagation Delay; NOTE 1	$f \leq$ 200MHz		3		ns
*t*sk(o)	Output Skew; NOTE 2, 4	Measured on rising edge @$V_{DDx}/2$		250		ps
*t*sk(pp)	Part-to-Part Skew; NOTE 3, 4	Measured on rising edge @$V_{DDx}/2$		1		ns
t_R / t_F	Output Rise/Fall Time	20% to 80%	0.4		1.0	ns
odc	Output Duty Cycle	$f \leq$ 133MHz		50		%

All parameters measured at f_{MAX} unless noted otherwise.
NOTE 1: Measured from $V_{DD}/2$ of the input to $V_{DDx}/2$ of the output.
NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at $V_{DDx}/2$.
NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at $V_{DDx}/2$.
NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

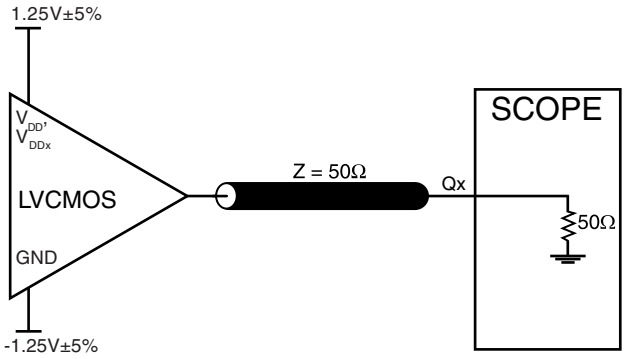
PARAMETER MEASUREMENT INFORMATION



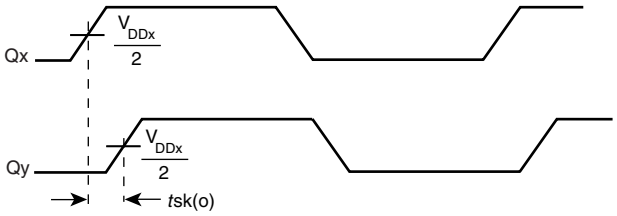
3.3V CORE/ 3.3V OUTPUT LOAD AC TEST CIRCUIT



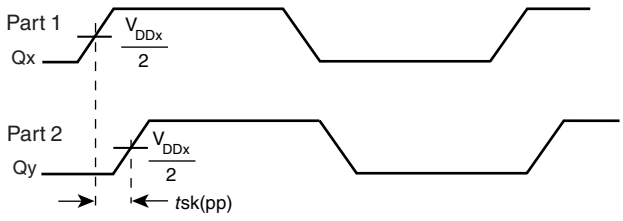
3.3V CORE/2.5V OUTPUT LOAD AC TEST CIRCUIT



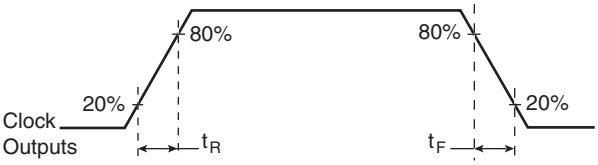
2.5V CORE/ 2.5V OUTPUT LOAD AC TEST CIRCUIT



OUTPUT SKEW

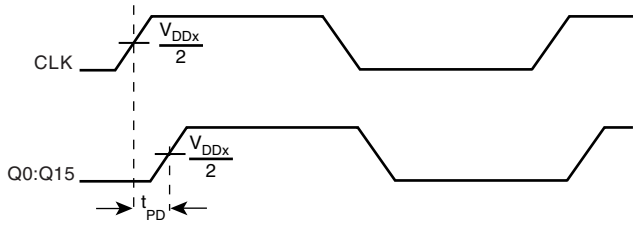


PART-TO-PART SKEW

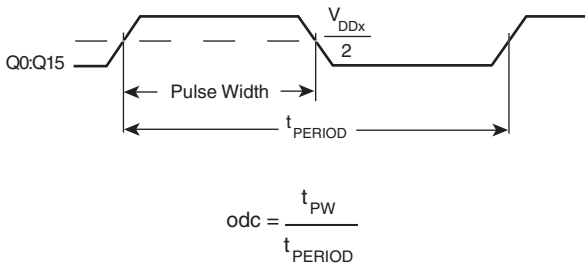


OUTPUT RISE/FALL TIME

PARAMETER MEASUREMENT INFORMATION, CONTINUED



PROPAGATION DELAY



OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

RELIABILITY INFORMATION

TABLE 6. θ_{JA} VS. AIR FLOW TABLE FOR 32 LEAD LQFP

θ_{JA} by Velocity (Meters per Second)			
	0	**1**	**2.5**
Multi-Layer PCB, JEDEC Standard Test Boards	73.6°C/W	63.9°C/W	60.3°C/W

TRANSISTOR COUNT

The transistor count for ICS8343I-01 is: 985

PACKAGE OUTLINE - Y SUFFIX FOR 32 LEAD LQFP

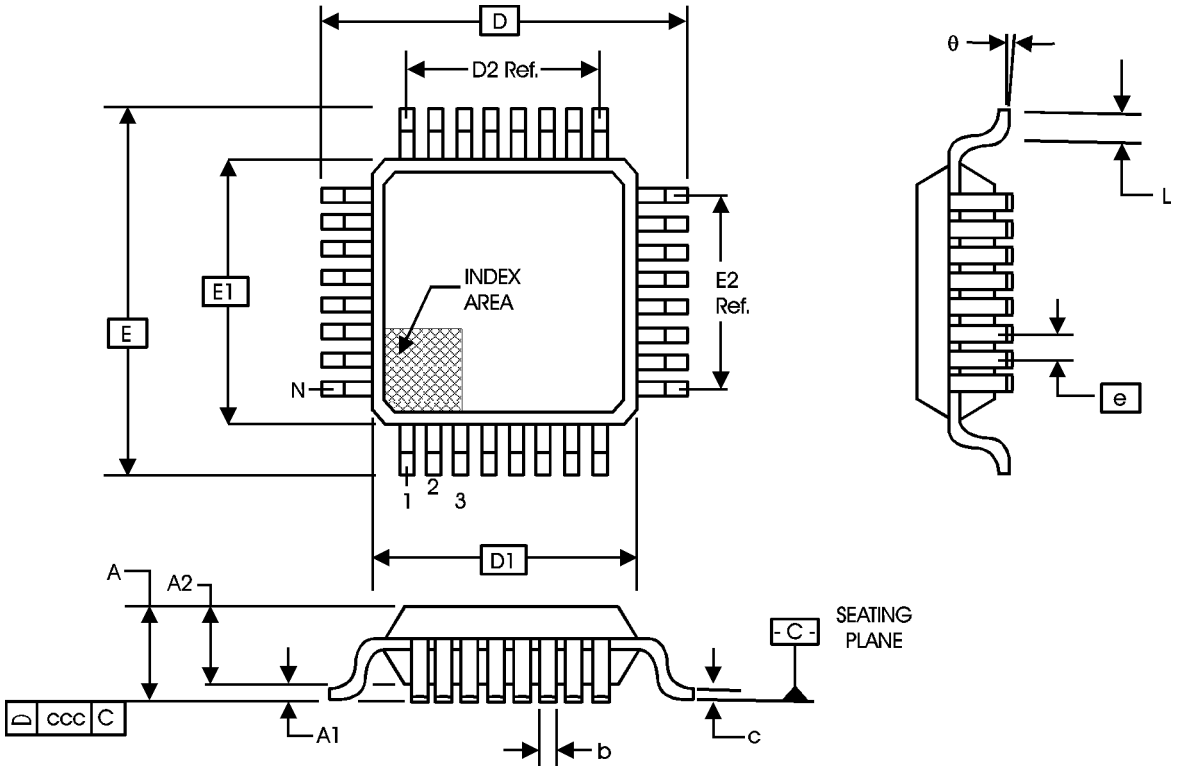


TABLE 7. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS			
SYMBOL	BBA		
	MINIMUM	NOMINAL	MAXIMUM
N		32	
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
c	0.09	--	0.20
D		9.00 BASIC	
D1		7.00 BASIC	
D2		5.60 Ref.	
E		9.00 BASIC	
E1		7.00 BASIC	
E2		5.60 Ref.	
e		0.80 BASIC	
L	0.45	0.60	0.75
θ	0°	--	7°
ccc	--	--	0.10

Reference Document: JEDEC Publication 95, MS-026

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
8343AYI-01	ICS8343AYI-01	32 Lead LQFP	Tray	-40°C to 85°C
8343AYI-01T	ICS8343AYI-01	32 Lead LQFP	1000 Tape & Reel	-40°C to 85°C